

MOS INTEGRATED CIRCUIT

μ PD42S17805L, 4217805L

3.3 V OPERATION 16 M-BIT DYNAMIC RAM 2 M-WORD BY 8-BIT, HYPER PAGE MODE

Description

The μ PD42S17805L, 4217805L are 2,097,152 words by 8 bits CMOS dynamic RAMs with optional hyper page mode.

Hyper page mode is a kind of the page mode and is useful for the read operation.

Besides, the μ PD42S17805L can execute $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ self refresh.

The μ PD42S17805L, 4217805L are packaged in 28-pin plastic TSOP (II) and 28-pin plastic SOJ.

Features

- Hyper page mode (EDO)
- 2,097,152 words by 8 bits organization
- Single +3.3 V \pm 0.3 V power supply

Part number	Power consumption Active (MAX.)	Access time (MAX.)	R/W cycle time (MIN.)	Hyper page mode cycle time (MIN.)
μ PD42S17805L-A60, 4217805L-A60	360 mW	60 ns	104 ns	25 ns
μ PD42S17805L-A70, 4217805L-A70	324 mW	70 ns	124 ns	30 ns

- The μ PD42S17805L can execute $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ self refresh

Part number	Refresh cycle	Refresh	Power consumption at standby (MAX.)
μ PD42S17805L	2,048 cycles/128 ms	$\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ self refresh, $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh, $\overline{\text{RAS}}$ only refresh, Hidden refresh	0.54 mW (CMOS level input)
μ PD4217805L	2,048 cycles/32 ms	$\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh, $\overline{\text{RAS}}$ only refresh, Hidden refresh	1.8 mW (CMOS level input)

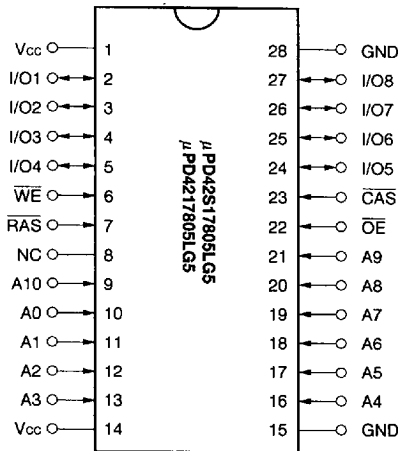
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Ordering Information

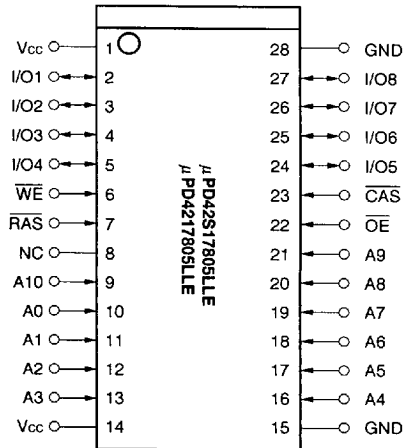
Part number	Access time (MAX.)	Package	Refresh
μPD42S17805LG5-A60	60 ns	28-pin Plastic TSOP (II) (400 mil)	$\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ self refresh
μPD42S17805LG5-A70	70 ns		$\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh
μPD42S17805LLE-A60	60 ns	28-pin Plastic SOJ (400 mil)	$\overline{\text{RAS}}$ only refresh
μPD42S17805LLE-A70	70 ns		Hidden refresh
μPD4217805LG5-A60	60 ns	28-pin Plastic TSOP (II) (400 mil)	$\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh
μPD4217805LG5-A70	70 ns		$\overline{\text{RAS}}$ only refresh
μPD4217805LLE-A60	60 ns	28-pin Plastic SOJ (400 mil)	Hidden refresh
μPD4217805LLE-A70	70 ns		

Pin Configurations (Marking Side)

28-pin Plastic TSOP (II) (400 mil)



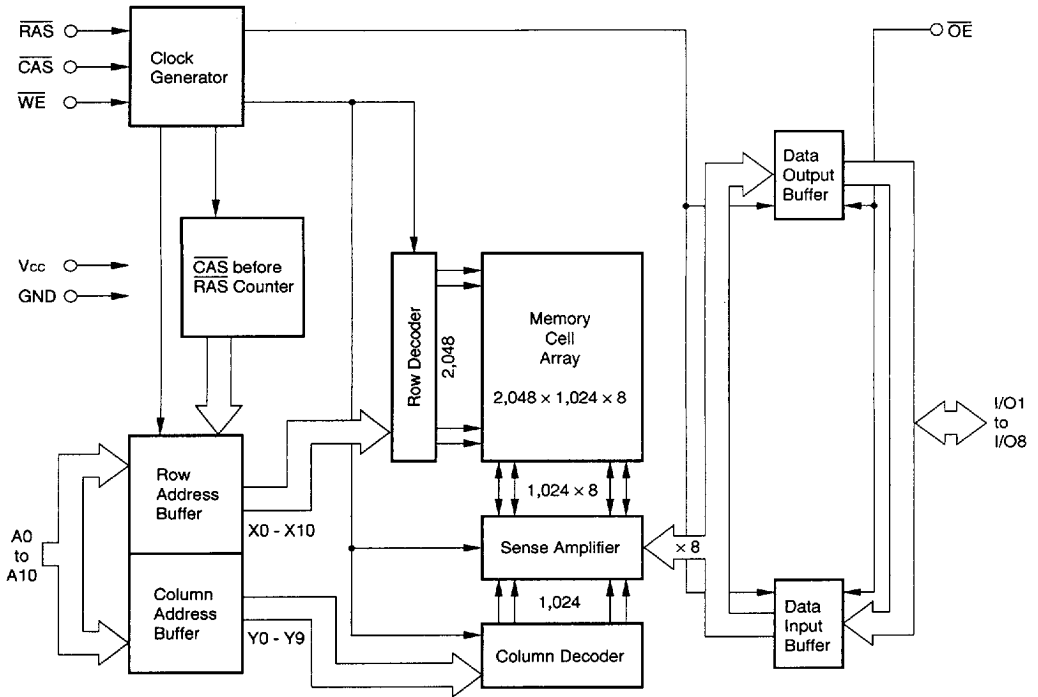
28-pin Plastic SOJ (400 mil)



- A0 to A10 : Address Inputs
- I/O1 to I/O8 : Data Inputs/Outputs
- RAS : Row Address Strobe
- CAS : Column Address Strobe
- WE : Write Enable
- OE : Output Enable
- Vcc : Power Supply
- GND : Ground
- NC : No Connection

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Block Diagram



Input/Output Pin Functions

The μPD42S17805L, 4217805L have input pins \overline{RAS} , \overline{CAS} , \overline{WE} , \overline{OE} , A0 to A10 and input/output pins I/O1 to I/O8.

Pin name	Input/Output	Function
\overline{RAS} (Row address strobe)	Input	\overline{RAS} activates the sense amplifier by latching a row address and selecting a corresponding word line. It refreshes memory cell array of one line selected by the row address. It also selects the following function. • \overline{CAS} before \overline{RAS} refresh
\overline{CAS} (Column address strobe)	Input	\overline{CAS} activates data input/output circuit by latching column address and selecting a digit line connected with the sense amplifier.
A0 to A10 (Address inputs)	Input	Address bus. Input total 21-bit of address signal, upper 11-bit and lower 10-bit in sequence (address multiplex method). Therefore, one word is selected from 2,097,152-word by 8-bit memory cell array. In actual operation, latch row address by specifying row address and activating \overline{RAS} . Then, switch the address bus to column address and activate \overline{CAS} . Each address is taken into the device when \overline{RAS} and \overline{CAS} are activated. Therefore, the address input setup time (t_{ASR} , t_{ASC}) and hold time (t_{RAH} , t_{CAH}) are specified for the activation of \overline{RAS} and \overline{CAS} .
\overline{WE} (Write enable)	Input	Write control signal. Write operation is executed by activating \overline{RAS} , \overline{CAS} and \overline{WE} .
\overline{OE} (Output enable)	Input	Read control signal. Read operation can be executed by activating \overline{RAS} , \overline{CAS} and \overline{OE} . If \overline{WE} is activated during read operation, \overline{OE} is to be ineffective in the device. Therefore, read operation cannot be executed.
I/O1 to I/O8 (Data inputs/outputs)	Input/Output	8-bit data bus. I/O1 to I/O8 are used to input/output data.

Hyper Page Mode

The hyper page mode is a kind of page mode with enhanced features. The two major features of the hyper page mode are as follows.

1. Data output time is extended.

In the hyper page mode, the output data is held to the next $\overline{\text{CAS}}$ cycle's falling edge, instead of the rising edge. For this reason, valid data output time in the hyper page mode is extended compared with the fast page mode (= data extend function). In the fast page mode, the data output time becomes shorter as the $\overline{\text{CAS}}$ cycle time becomes shorter. Therefore, in the hyper page mode, the timing margin in read cycle is larger than that of the fast page mode even if the $\overline{\text{CAS}}$ cycle time becomes shorter.

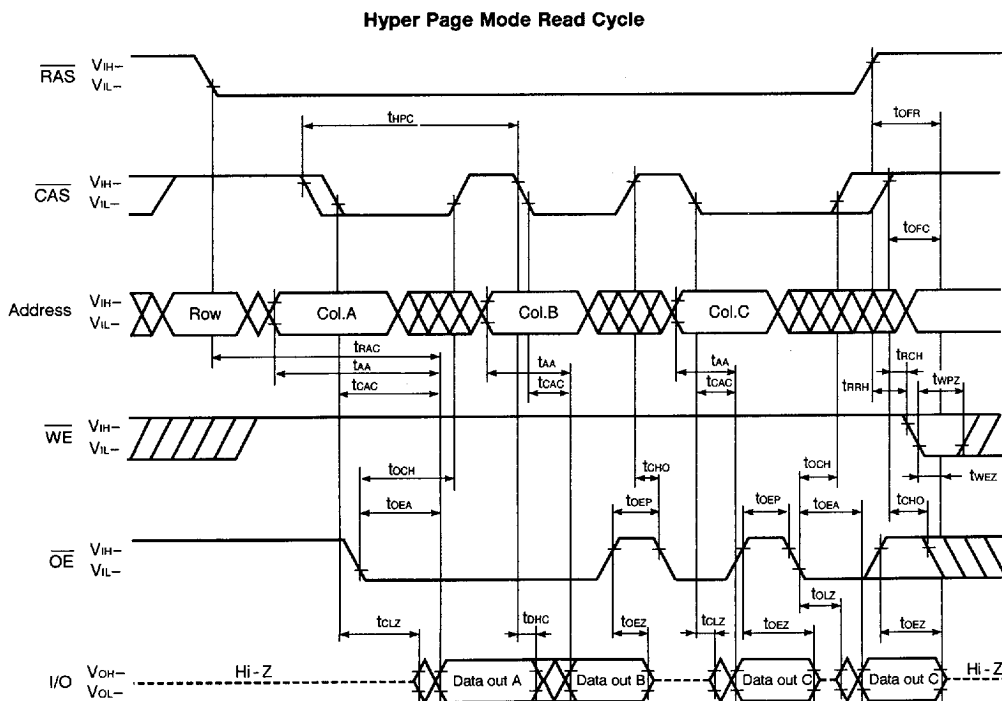
2. The $\overline{\text{CAS}}$ cycle time in the hyper page mode is shorter than that in the fast page mode.

In the hyper page mode, due to the data extend function, the $\overline{\text{CAS}}$ cycle time can be shorter than in the fast page mode if the timing margin is the same.

Taking a device whose t_{RAC} is 60 ns as an example, the $\overline{\text{CAS}}$ cycle time in the fast page mode is 25 ns while that in the hyper page mode is 40 ns.

In the hyper page mode, read (data out) and write (data in) cycles can be executed repeatedly during one $\overline{\text{RAS}}$ cycle. The hyper page mode allows both read and write operations during one cycle, but the performance is equivalent to that of the fast page mode in that case.

The following shows a part of the hyper page mode read cycle. Specifications to be observed are described in the next page.



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Cautions when using the hyper page mode

1. $\overline{\text{CAS}}$ access should be used to operate t_{HPC} at the MIN. value.
2. To make I/Os to Hi-Z in read cycle, it is necessary to control $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{WE}}$, $\overline{\text{OE}}$ as follows. The effective specification depends on the state of each signal.
 - (1) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are inactive (at the end of read cycle)
 $\overline{\text{WE}}$: inactive, $\overline{\text{OE}}$: active
 t_{OFC} is effective when $\overline{\text{RAS}}$ is inactivated before $\overline{\text{CAS}}$ is inactivated.
 t_{OFR} is effective when $\overline{\text{CAS}}$ is inactivated before $\overline{\text{RAS}}$ is inactivated.
 - (2) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are active or either $\overline{\text{RAS}}$ or $\overline{\text{CAS}}$ is active (in read cycle)
 $\overline{\text{WE}}$, $\overline{\text{OE}}$: inactive t_{OZ} is effective.
 - (3) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are inactive or $\overline{\text{RAS}}$ is active and $\overline{\text{CAS}}$ is inactive (at the end of read cycle)
 $\overline{\text{WE}}$, $\overline{\text{OE}}$: active and either t_{RRH} or t_{RCH} must be met t_{WEZ} and t_{WPZ} are effective.
3. In read cycle, the effective specification depends on the state of $\overline{\text{CAS}}$ signal when controlling data output with the $\overline{\text{OE}}$ signal.
 - (1) $\overline{\text{CAS}}$: inactive, $\overline{\text{OE}}$: active t_{CHO} is effective.
 - (2) $\overline{\text{CAS}}$, $\overline{\text{OE}}$: active t_{CH} is effective.

Electrical Specifications

- All voltages are referenced to GND.
- After power up ($V_{CC} \geq V_{CC(MIN)}$), wait more than 100 μs (\overline{RAS} , \overline{CAS} inactive) and then, execute eight \overline{CAS} before \overline{RAS} or \overline{RAS} only refresh cycles as dummy cycles to initialize internal circuit.

Absolute Maximum Ratings

Parameter	Symbol	Condition	Rating	Unit
Voltage on any pin relative to GND	V_T		-0.5 to +4.6	V
Supply voltage	V_{CC}		-0.5 to +4.6	V
Output current	I_O		20	mA
Power dissipation	P_D		1	W
Operating ambient temperature	T_A		0 to +70	°C
Storage temperature	T_{STG}		-55 to +125	°C

Caution Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Supply voltage	V_{CC}		3.0	3.3	3.6	V
High level input voltage	V_{IH}		2.0		$V_{CC} + 0.3$	V
Low level input voltage	V_{IL}		-0.3		+0.8	V
Operating ambient temperature	T_A		0		70	°C

Capacitance ($T_A = 25\text{ °C}$, $f = 1\text{ MHz}$)

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
Input capacitance	C_{I1}	Address			5	pF
	C_{I2}	\overline{RAS} , \overline{CAS} , \overline{WE} , \overline{OE}			7	
Data input/output capacitance	$C_{I/O}$	I/O			7	pF

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DC Characteristics (Recommended operating conditions unless otherwise noted)

Parameter		Symbol	Test Condition	MIN.	MAX.	Unit	Notes
Operating current		I _{CC1}	$\overline{RAS}, \overline{CAS}$ Cycling $t_{RC} = t_{RC(MIN.)}, I_o = 0 \text{ mA}$	$t_{RAC} = 60 \text{ ns}$	100	mA	1, 2, 3
				$t_{RAC} = 70 \text{ ns}$	90		
Standby current	μPD42S17805L	I _{CC2}	$\overline{RAS}, \overline{CAS} \geq V_{IH(MIN.)}, I_o = 0 \text{ mA}$		0.5	mA	
			$\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2 \text{ V}, I_o = 0 \text{ mA}$		0.15		
	μPD4217805L		$\overline{RAS}, \overline{CAS} \geq V_{IH(MIN.)}, I_o = 0 \text{ mA}$		2.0		
	$\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2 \text{ V}, I_o = 0 \text{ mA}$			0.5			
\overline{RAS} only refresh current		I _{CC3}	\overline{RAS} Cycling, $\overline{CAS} \geq V_{IH(MIN.)}$ $t_{RC} = t_{RC(MIN.)}, I_o = 0 \text{ mA}$	$t_{RAC} = 60 \text{ ns}$	100	mA	1, 2, 3, 4
$t_{RAC} = 70 \text{ ns}$	90						
Operating current (Hyper page mode)		I _{CC4}	$\overline{RAS} \leq V_{IL(MAX.)}, \overline{CAS}$ Cycling $t_{HPC} = t_{HPC(MIN.)}, I_o = 0 \text{ mA}$	$t_{RAC} = 60 \text{ ns}$	90	mA	1, 2, 5
$t_{RAC} = 70 \text{ ns}$	80						
\overline{CAS} before \overline{RAS} refresh current		I _{CC5}	\overline{RAS} Cycling $t_{RC} = t_{RC(MIN.)}, I_o = 0 \text{ mA}$	$t_{RAC} = 60 \text{ ns}$	100	mA	1, 2
$t_{RAC} = 70 \text{ ns}$	90						
\overline{CAS} before \overline{RAS} long refresh current (2,048 cycles / 128 ms, only for the μPD42S17805L)		I _{CC6}	\overline{CAS} before \overline{RAS} refresh: $t_{RC} = 62.5 \mu\text{s}$ $\overline{RAS}, \overline{CAS}$: $V_{CC} - 0.2 \text{ V} \leq V_{IH} \leq V_{IH(MAX.)}$ $0 \text{ V} \leq V_{IL} \leq 0.2 \text{ V}$ Standby: $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2 \text{ V}$ Address: V_{IH} or V_{IL} $\overline{WE}, \overline{OE}$: V_{IH} $I_o = 0 \text{ mA}$	$t_{RAS} \leq 1 \mu\text{s}$	200	μA	1, 2
\overline{CAS} before \overline{RAS} self refresh current (only for the μPD42S17805L)				I _{CC7}	$\overline{RAS}, \overline{CAS}$: $t_{RASS} = 5 \text{ ms}$ $V_{CC} - 0.2 \text{ V} \leq V_{IH} \leq V_{IH(MAX.)}$ $0 \text{ V} \leq V_{IL} \leq 0.2 \text{ V}$ $I_o = 0 \text{ mA}$		150
Input leakage current		I _{I(L)}	$V_I = 0 \text{ to } 3.6 \text{ V}$ All other pins not under test = 0 V			-5	+5
Output leakage current		I _{O(L)}	$V_O = 0 \text{ to } 3.6 \text{ V}$ Output is disabled (Hi-Z)	-5	+5	μA	
High level output voltage		V _{OH}	$I_o = -2.0 \text{ mA}$	2.4		V	
Low level output voltage		V _{OL}	$I_o = +2.0 \text{ mA}$		0.4	V	

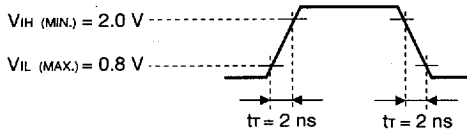
- Notes**
- I_{CC1}, I_{CC3}, I_{CC4}, I_{CC5} and I_{CC6} depend on cycle rates (t_{RC} and t_{HPC}).
 - Specified values are obtained with outputs unloaded.
 - I_{CC1} and I_{CC3} are measured assuming that address can be changed once or less during $\overline{RAS} \leq V_{IL(MAX.)}$ and $\overline{CAS} \geq V_{IH(MIN.)}$.
 - I_{CC3} is measured assuming that all column address inputs are held at either high or low.
 - I_{CC4} is measured assuming that all column address inputs are switched only once during each hyper page cycle.

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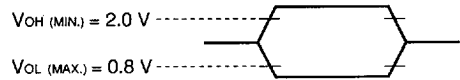
AC Characteristics (Recommended Operating Conditions unless otherwise noted)

AC Characteristics Test Conditions

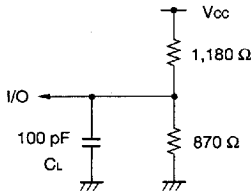
(1) Input timing specification



(2) Output timing specification



(3) Output load condition



Common to Read, Write, Read Modify Write Cycle

Parameter	Symbol	$t_{RAC} = 60 ns$		$t_{RAC} = 70 ns$		Unit	Notes	
		MIN.	MAX.	MIN.	MAX.			
Read / Write Cycle Time	t_{RC}	104	—	124	—	ns		
\overline{RAS} Precharge Time	t_{RP}	40	—	50	—	ns		
\overline{CAS} Precharge Time	t_{CPN}	10	—	10	—	ns		
\overline{RAS} Pulse Width	t_{RAS}	60	10,000	70	10,000	ns	1	
\overline{CAS} Pulse Width	t_{CAS}	10	10,000	12	10,000	ns		
\overline{RAS} Hold Time	t_{RSH}	10	—	12	—	ns		
\overline{CAS} Hold Time	t_{CSH}	40	—	50	—	ns		
\overline{RAS} to \overline{CAS} Delay Time	t_{RCD}	14	45	14	52	ns	2	
\overline{RAS} to Column Address Delay Time	t_{RAD}	12	30	12	35	ns	2	
\overline{CAS} to \overline{RAS} Precharge Time	t_{CRP}	5	—	5	—	ns	3	
Row Address Setup Time	t_{ASR}	0	—	0	—	ns		
Row Address Hold Time	t_{RAH}	10	—	10	—	ns		
Column Address Setup Time	t_{ASC}	0	—	0	—	ns		
Column Address Hold Time	t_{CAH}	10	—	12	—	ns		
\overline{OE} Lead Time Referenced to \overline{RAS}	t_{OES}	0	—	0	—	ns		
\overline{CAS} to Data Setup Time	t_{CLZ}	0	—	0	—	ns		
\overline{OE} to Data Setup Time	t_{OLZ}	0	—	0	—	ns		
\overline{OE} to Data Delay Time	t_{OED}	13	—	15	—	ns		
Transition Time (Rise and Fall)	t_T	1	50	1	50	ns		
Refresh Time	t_{REF}	μPD42S17805L	—	128	—	128	ms	4
		μPD4217805L	—	32	—	32	ms	

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- Notes**
- In $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh cycles, $t_{\text{RAS}}(\text{MAX.})$ is 100 μs.
If $10 \mu\text{s} < t_{\text{RAS}} < 100 \mu\text{s}$, $\overline{\text{RAS}}$ precharge time for $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ self refresh (t_{RPS}) is applied.
 - For read cycles, access time is defined as follows:

Input Conditions	Access Time	Access Time from $\overline{\text{RAS}}$
$t_{\text{RAD}} \leq t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \leq t_{\text{RCD}}(\text{MAX.})$	$t_{\text{RAC}}(\text{MAX.})$	$t_{\text{RAC}}(\text{MAX.})$
$t_{\text{RAD}} > t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \leq t_{\text{RCD}}(\text{MAX.})$	$t_{\text{AA}}(\text{MAX.})$	$t_{\text{RAD}} + t_{\text{AA}}(\text{MAX.})$
$t_{\text{RCD}} > t_{\text{RCD}}(\text{MAX.})$	$t_{\text{CAC}}(\text{MAX.})$	$t_{\text{RCD}} + t_{\text{CAC}}(\text{MAX.})$

$t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}}(\text{MAX.})$ are specified as reference points only; they are not restrictive operating parameters. They are used to determine which access time (t_{RAC} , t_{AA} or t_{CAC}) is to be used for finding out when output data will be available. Therefore, the input conditions $t_{\text{RAD}} \geq t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \geq t_{\text{RCD}}(\text{MAX.})$ will not cause any operation problems.

- $t_{\text{CRP}}(\text{MIN.})$ requirement is applied to $\overline{\text{RAS}}$, $\overline{\text{CAS}}$ cycles.
- This specification is applied only to the μPD42S17805L.

Read Cycle

Parameter	Symbol	$t_{\text{RAC}} = 60 \text{ ns}$		$t_{\text{RAC}} = 70 \text{ ns}$		Unit	Notes
		MIN.	MAX.	MIN.	MAX.		
Access Time from $\overline{\text{RAS}}$	t_{RAC}	–	60	–	70	ns	1
Access Time from $\overline{\text{CAS}}$	t_{CAC}	–	15	–	18	ns	1
Access Time from Column Address	t_{AA}	–	30	–	35	ns	1
Access Time from $\overline{\text{OE}}$	t_{OEA}	–	15	–	18	ns	
Column Address Lead Time Referenced to $\overline{\text{RAS}}$	t_{RAL}	30	–	35	–	ns	
Read Command Setup Time	t_{RCS}	0	–	0	–	ns	
Read Command Hold Time Referenced to $\overline{\text{RAS}}$	t_{RRH}	0	–	0	–	ns	2
Read Command Hold Time Referenced to $\overline{\text{CAS}}$	t_{RCH}	0	–	0	–	ns	2
Output Buffer Turn-off Delay Time from $\overline{\text{OE}}$	t_{OEZ}	0	13	0	15	ns	3
$\overline{\text{CAS}}$ Hold Time to $\overline{\text{OE}}$	t_{CHO}	5	–	5	–	ns	

- Notes**
- For read cycles, access time is defined as follows:

Input Conditions	Access Time	Access Time from $\overline{\text{RAS}}$
$t_{\text{RAD}} \leq t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \leq t_{\text{RCD}}(\text{MAX.})$	$t_{\text{RAC}}(\text{MAX.})$	$t_{\text{RAC}}(\text{MAX.})$
$t_{\text{RAD}} > t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \leq t_{\text{RCD}}(\text{MAX.})$	$t_{\text{AA}}(\text{MAX.})$	$t_{\text{RAD}} + t_{\text{AA}}(\text{MAX.})$
$t_{\text{RCD}} > t_{\text{RCD}}(\text{MAX.})$	$t_{\text{CAC}}(\text{MAX.})$	$t_{\text{RCD}} + t_{\text{CAC}}(\text{MAX.})$

$t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}}(\text{MAX.})$ are specified as reference points only; they are not restrictive operating parameters. They are used to determine which access time (t_{RAC} , t_{AA} or t_{CAC}) is to be used for finding out when output data will be available. Therefore, the input conditions $t_{\text{RAD}} \geq t_{\text{RAD}}(\text{MAX.})$ and $t_{\text{RCD}} \geq t_{\text{RCD}}(\text{MAX.})$ will not cause any operation problems.

- Either $t_{\text{RCH}}(\text{MIN.})$ or $t_{\text{RRH}}(\text{MIN.})$ should be met in read cycles.
- $t_{\text{OEZ}}(\text{MAX.})$ defines the time when the output achieves the condition of Hi-Z and is not referenced to V_{OH} or V_{OL} .

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Write Cycle

Parameter	Symbol	t _{TRAC} = 60 ns		t _{TRAC} = 70 ns		Unit	Notes
		MIN.	MAX.	MIN.	MAX.		
\overline{WE} Hold Time Referenced to \overline{CAS}	t _{wch}	10	–	10	–	ns	1
\overline{WE} Pulse Width	t _{wp}	10	–	10	–	ns	1
\overline{WE} Lead Time Referenced to \overline{RAS}	t _{rwL}	10	–	12	–	ns	
\overline{WE} Lead Time Referenced to \overline{CAS}	t _{cwL}	10	–	12	–	ns	
\overline{WE} Setup Time	t _{wcs}	0	–	0	–	ns	2
\overline{OE} Hold Time	t _{oEH}	0	–	0	–	ns	
Data-in Setup Time	t _{DS}	0	–	0	–	ns	3
Data-in Hold Time	t _{DH}	10	–	10	–	ns	3

- Notes**
1. t_{wp} (MIN.) is applied to late write cycles or read modify write cycles. In early write cycles, t_{wch} (MIN.) should be met.
 2. If t_{wcs} ≥ t_{wcs} (MIN.), the cycle is an early write cycle and the data out will remain Hi-Z through the entire cycle.
 3. t_{DS} (MIN.) and t_{DH} (MIN.) are referenced to the \overline{CAS} falling edge in early write cycles. In late write cycles and read modify write cycles, they are referenced to the \overline{WE} falling edge.

Read Modify Write Cycle

Parameter	Symbol	t _{TRAC} = 60 ns		t _{TRAC} = 70 ns		Unit	Note
		MIN.	MAX.	MIN.	MAX.		
Read Modify Write Cycle Time	t _{rwC}	133	–	157	–	ns	
RAS to \overline{WE} Delay Time	t _{rwD}	77	–	89	–	ns	1
CAS to \overline{WE} Delay Time	t _{cwD}	32	–	37	–	ns	1
Column Address to \overline{WE} Delay Time	t _{awD}	47	–	54	–	ns	1

- Note**
1. If t_{wcs} ≥ t_{wcs} (MIN.), the cycle is an early write cycle and the data out will remain Hi-Z through the entire cycle. If t_{rwD} ≥ t_{rwD} (MIN.), t_{cwD} ≥ t_{cwD} (MIN.), t_{awD} ≥ t_{awD} (MIN.) and t_{CPWD} ≥ t_{CPWD} (MIN.), the cycle is a read modify write cycle and the data out will contain data read from the selected cell. If neither of the above conditions is met, the state of the data out is indeterminate.

Hyper Page Mode

Parameter	Symbol	t _{HAC} = 60 ns		t _{HAC} = 70 ns		Unit	Notes
		MIN.	MAX.	MIN.	MAX.		
Read / Write Cycle Time	t _{HPC}	25	—	30	—	ns	1
RAS Pulse Width	t _{RASP}	60	125,000	70	125,000	ns	
CAS Pulse Width	t _{HCAS}	10	10,000	12	10,000	ns	
CAS Precharge Time	t _{CP}	10	—	10	—	ns	
Access Time from $\overline{\text{CAS}}$ Precharge	t _{ACP}	—	35	—	40	ns	
CAS Precharge to $\overline{\text{WE}}$ Delay Time	t _{CPWD}	52	—	59	—	ns	2
RAS Hold Time from $\overline{\text{CAS}}$ Precharge	t _{RHCP}	35	—	40	—	ns	
Read Modify Write Cycle Time	t _{HPRWC}	66	—	75	—	ns	
Data Output Hold Time	t _{DHC}	5	—	5	—	ns	
$\overline{\text{OE}}$ to $\overline{\text{CAS}}$ Hold Time	t _{OCH}	5	—	5	—	ns	4
$\overline{\text{OE}}$ Precharge Time	t _{OEP}	5	—	5	—	ns	
Output Buffer Turn-off Delay from $\overline{\text{WE}}$	t _{WEZ}	0	13	0	15	ns	3,4
$\overline{\text{WE}}$ Pulse Width	t _{WPZ}	10	—	10	—	ns	4
Output Buffer Turn-off Delay from $\overline{\text{RAS}}$	t _{OFR}	0	13	0	15	ns	3,4
Output Buffer Turn-off Delay from $\overline{\text{CAS}}$	t _{OFC}	0	13	0	15	ns	3,4

- Notes**
1. t_{HPC} (MIN.) is applied to $\overline{\text{CAS}}$ access.
 2. If t_{WCS} ≥ t_{WCS} (MIN.), the cycle is an early write cycle and the data out will remain Hi-Z through the entire cycle. If t_{RWD} ≥ t_{RWD} (MIN.), t_{CWD} ≥ t_{CWD} (MIN.), t_{AWD} ≥ t_{AWD} (MIN.) and t_{CPWD} ≥ t_{CPWD} (MIN.), the cycle is a read modify write cycle and the data out will contain data read from the selected cell. If neither of the above conditions is met, the state of the data out is indeterminate.
 3. t_{OFC} (MAX.), t_{OFR} (MAX.) and t_{WEZ} (MAX.) define the time when the output achieves the conditions of Hi-Z and is not referenced to V_{OH} or V_{OL}.
 4. To make I/Os to Hi-Z in read cycle, it is necessary to control $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{WE}}$, $\overline{\text{OE}}$ as follows. The effective specification depends on state of each signal.
 - (1) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are inactive (at the end of the read cycle)
 $\overline{\text{WE}}$: inactive, $\overline{\text{OE}}$: active
 t_{OFC} is effective when $\overline{\text{RAS}}$ is inactivated before $\overline{\text{CAS}}$ is inactivated.
 t_{OFR} is effective when $\overline{\text{CAS}}$ is inactivated before $\overline{\text{RAS}}$ is inactivated.
 - (2) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are active or either $\overline{\text{RAS}}$ or $\overline{\text{CAS}}$ is active (in read cycle)
 $\overline{\text{WE}}$, $\overline{\text{OE}}$: inactive t_{OEZ} is effective.
 - (3) Both $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ are inactive or $\overline{\text{RAS}}$ is active and $\overline{\text{CAS}}$ is inactive (at the end of read cycle)
 $\overline{\text{WE}}$, $\overline{\text{OE}}$: active and either t_{RRH} or t_{RCH} must be met t_{WEZ} and t_{WPZ} are effective.
 - (4) $\overline{\text{WE}}$: inactive (in read cycle)
 $\overline{\text{CAS}}$: inactive, $\overline{\text{OE}}$: active t_{CHO} is effective.
 $\overline{\text{CAS}}$, $\overline{\text{OE}}$: active t_{OCH} is effective.

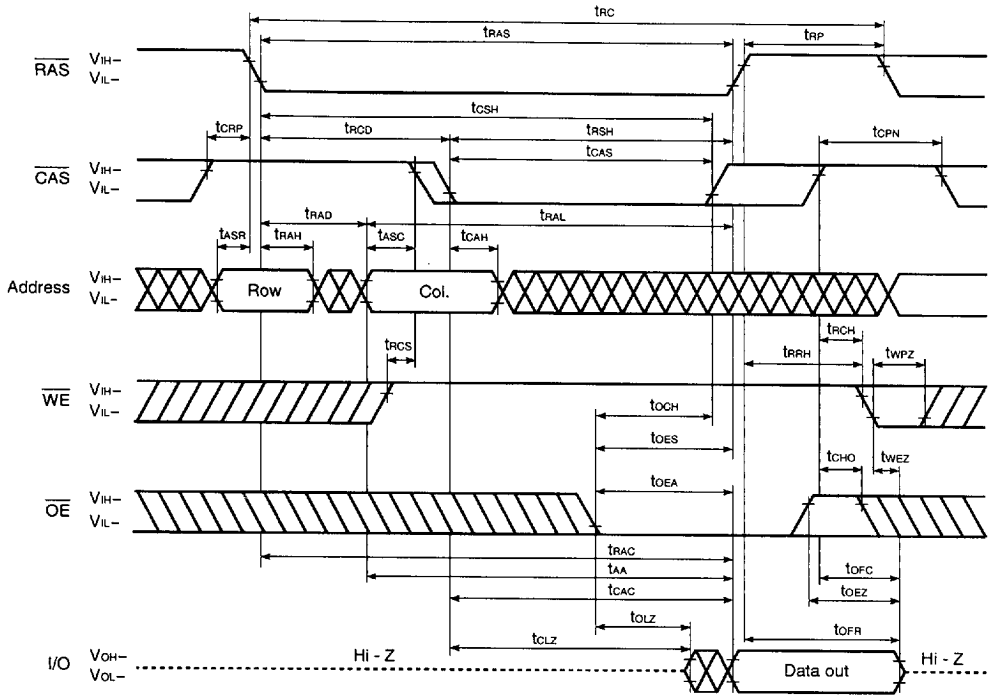
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Refresh Cycle

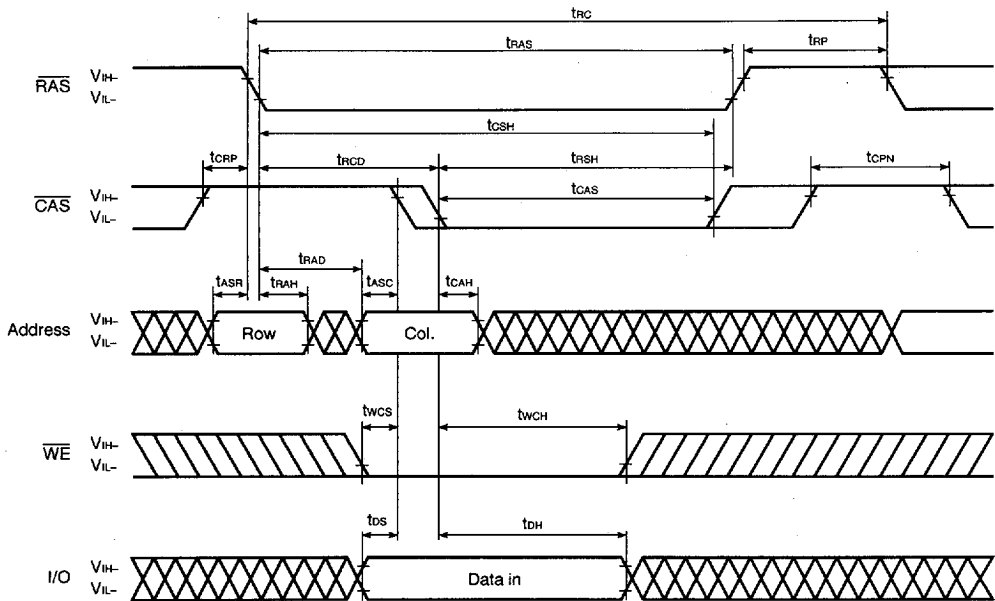
Parameter	Symbol	t _{RAC} = 60 ns		t _{RAC} = 70 ns		Unit	Note
		MIN.	MAX.	MIN.	MAX.		
CAS Setup Time	t _{CSR}	5	-	5	-	ns	
CAS Hold Time (CAS before RAS Refresh)	t _{CHR}	10	-	10	-	ns	
RAS Precharge CAS Hold Time	t _{RPC}	5	-	5	-	ns	
RAS Pulse Width (CAS before RAS Self Refresh)	t _{RASS}	100	-	100	-	μs	1
RAS Precharge Time (CAS before RAS Self Refresh)	t _{RPS}	110	-	130	-	ns	1
CAS Hold Time (CAS before RAS Self Refresh)	t _{CHS}	-50	-	-50	-	ns	1
WE Setup Time	t _{WSR}	10	-	10	-	ns	
WE Hold Time	t _{WHR}	15	-	15	-	ns	

Note 1. This specification is applied only to the μPD42S17805L.

Read Cycle

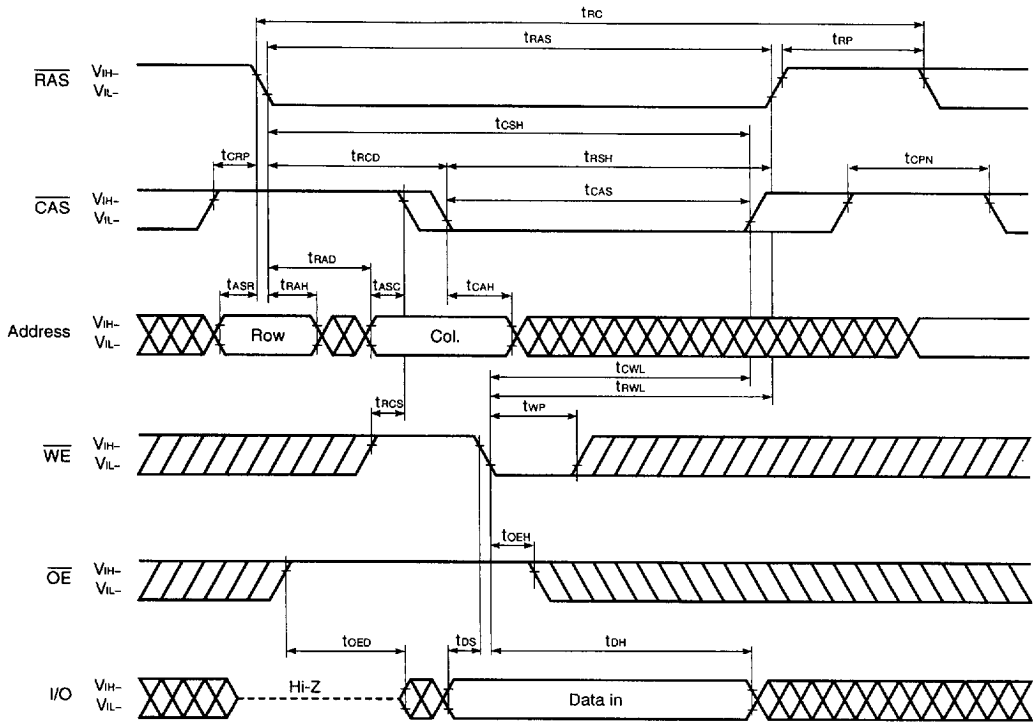


Early Write Cycle



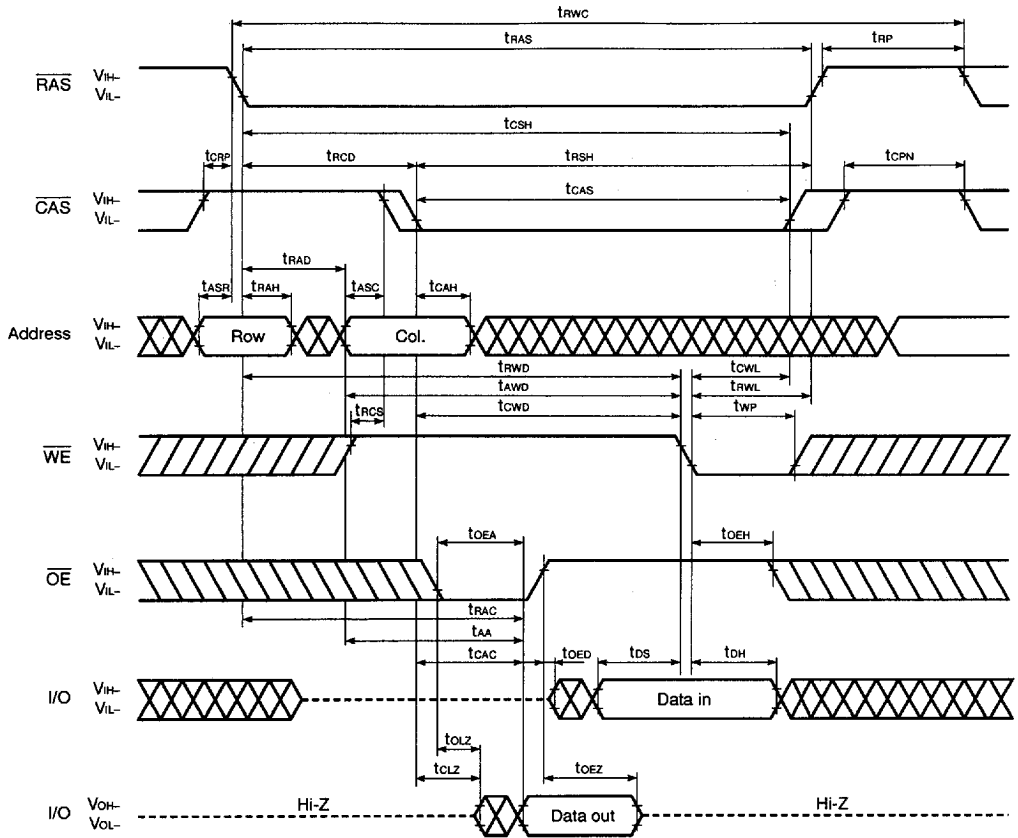
Remark \overline{OE} : Don't care

Late Write Cycle

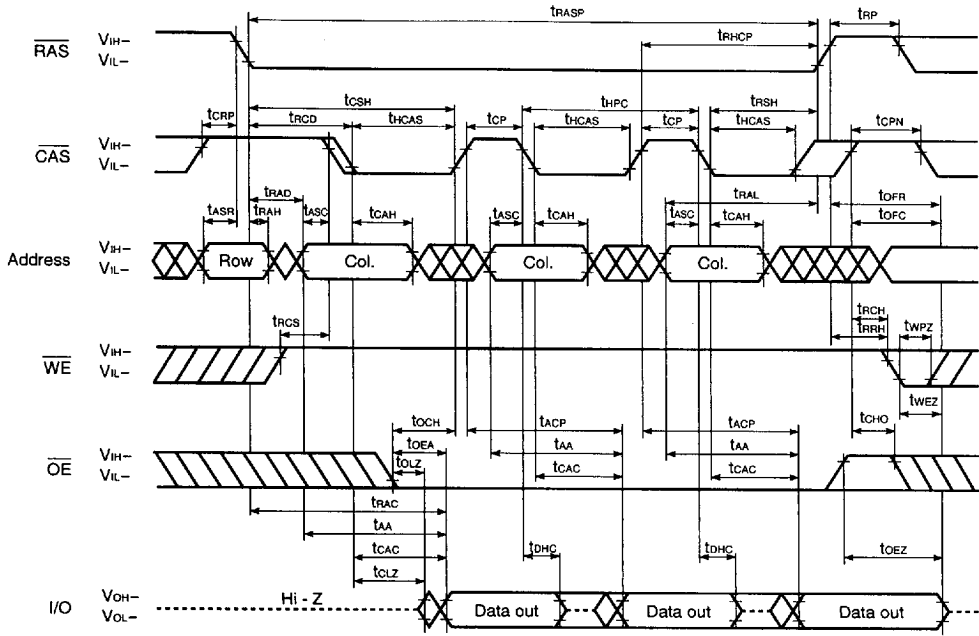


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Read Modify Write Cycle

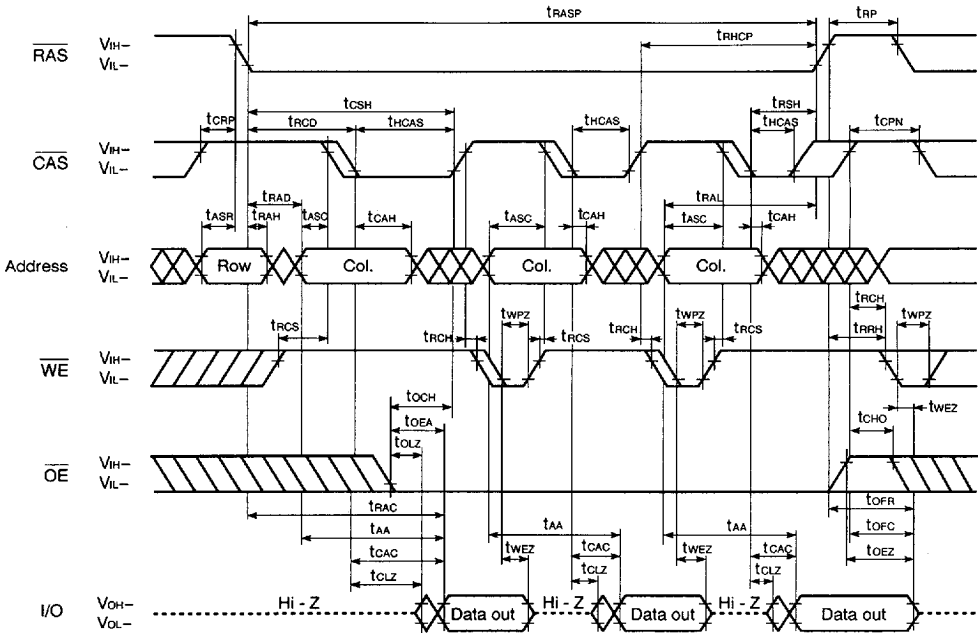


Hyper Page Mode Read Cycle



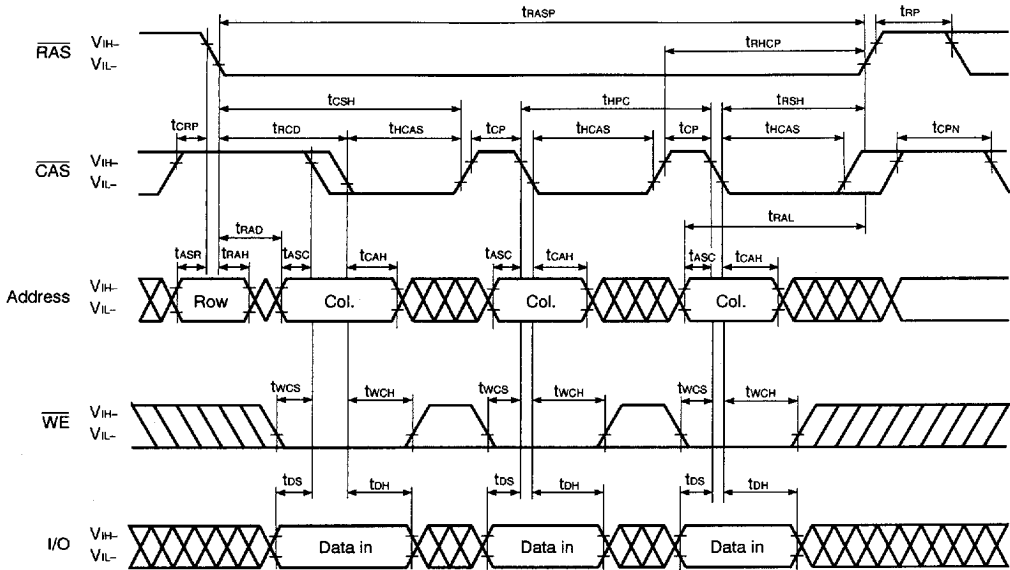
Remark In the hyper page mode, read, write and read modify write cycles are available for each of the consecutive $\overline{\text{CAS}}$ cycles within the same $\overline{\text{RAS}}$ cycle.

Hyper Page Mode Read Cycle (\overline{WE} Control)



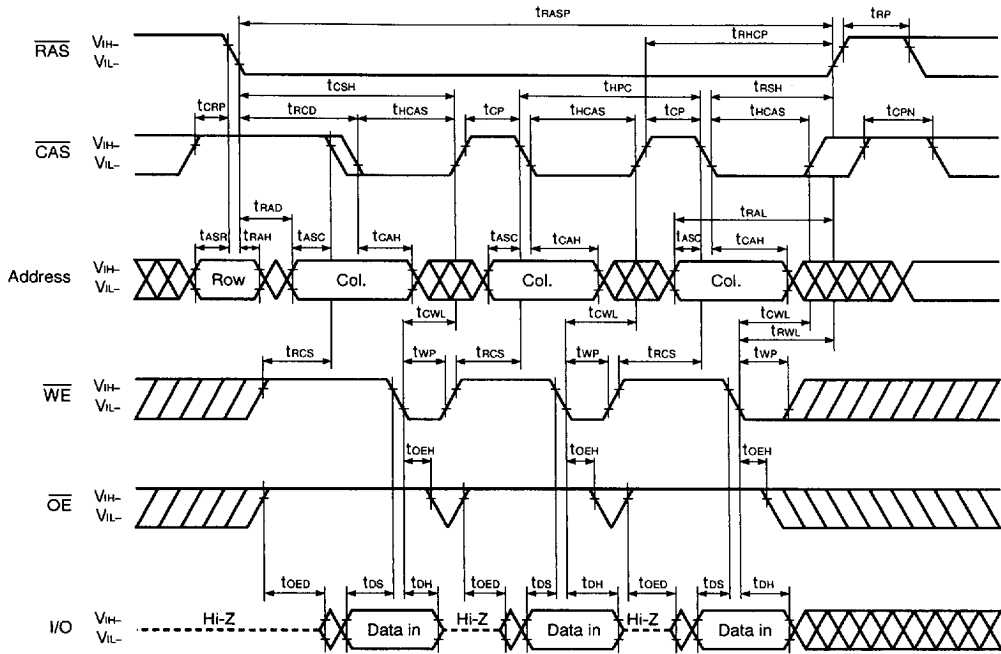
Remark In the hyper page mode, read, write and read modify write cycles are available for each of the consecutive \overline{CAS} cycles within the same \overline{RAS} cycle.

Hyper Page Mode Early Write Cycle



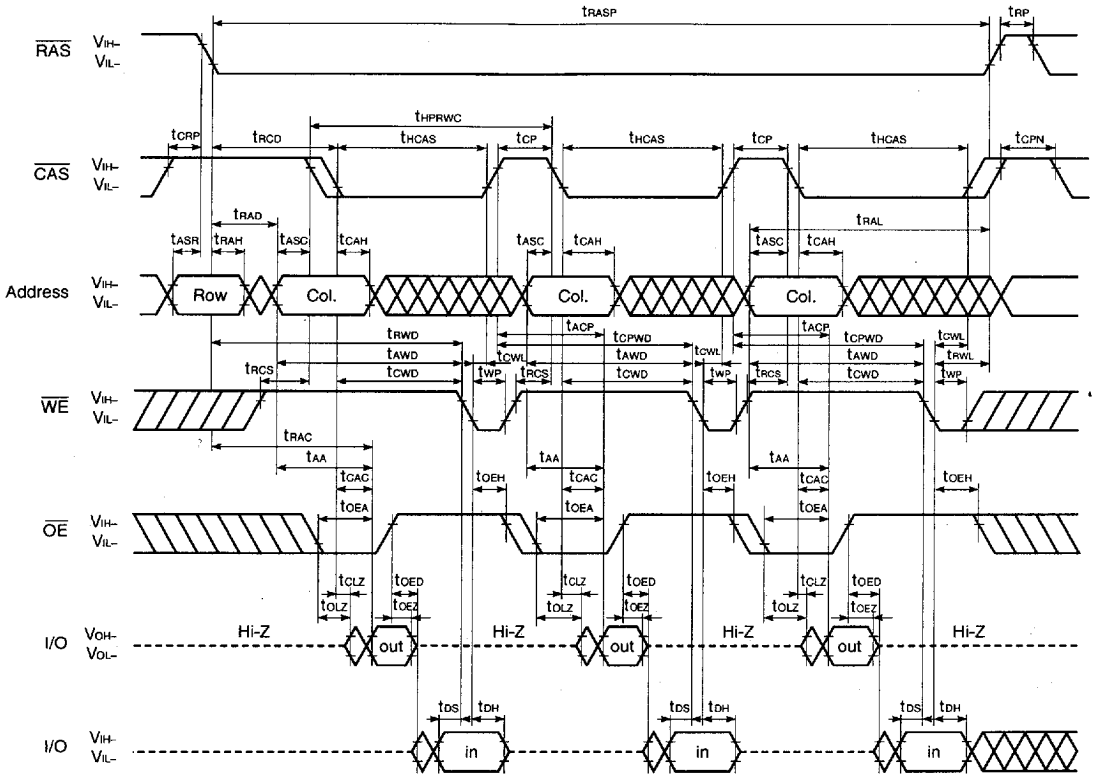
- Remarks**
1. $\overline{\text{OE}}$: Don't care
 2. In the hyper page mode, read, write and read modify write cycles are available for each of the consecutive $\overline{\text{CAS}}$ cycles within the same $\overline{\text{RAS}}$ cycle.

Hyper Page Mode Late Write Cycle



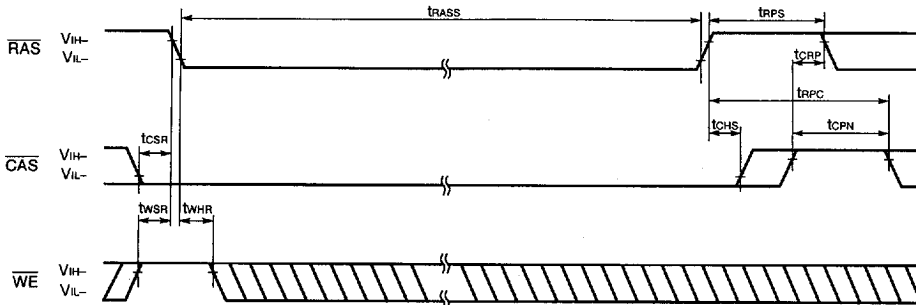
Remark In the hyper page mode, read, write and read modify write cycles are available for each of the consecutive CAS cycles within the same RAS cycle.

Hyper Page Mode Read Modify Write Cycle



Remark In the hyper page mode, read, write and read modify write cycles are available for each of the consecutive CAS cycles within the same RAS cycle.

CAS Before RAS Self Refresh Cycle (Only for the μPD42S17805L)



Remark Address, \overline{OE} : Don't care I/O : Hi-Z

Cautions on Use of CAS Before RAS Self Refresh

CAS before RAS self refresh can be used independently when used in combination with distributed CAS before RAS long refresh; However, when used in combination with burst CAS before RAS long refresh or with long RAS only refresh (both distributed and burst), the following cautions must be observed.

(1) Normal Combined Use of CAS Before RAS Self Refresh and Burst CAS Before RAS Long Refresh

When CAS before RAS self refresh and burst CAS before RAS long refresh are used in combination, please perform CAS before RAS refresh 2,048 times within a 32 ms interval just before and after setting CAS before RAS self refresh.

(2) Normal Combined Use of CAS Before RAS Self Refresh and Long RAS Only Refresh

When CAS before RAS self refresh and RAS only refresh are used in combination, please perform RAS only refresh 2,048 times within a 32 ms interval just before and after setting CAS before RAS self refresh.

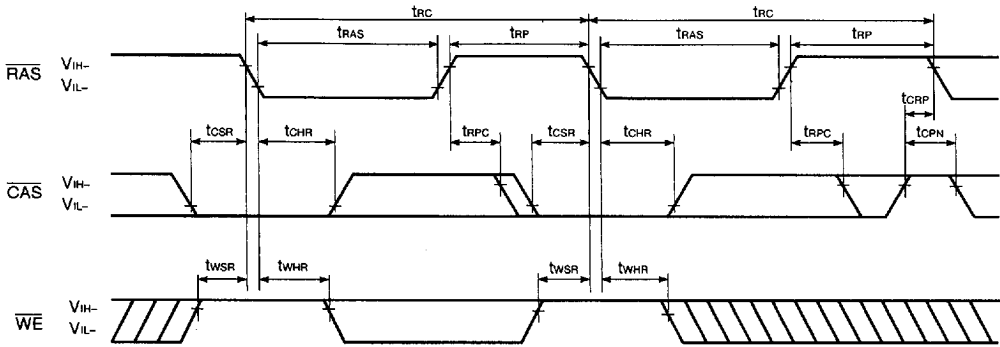
(3) If $t_{RASS(MIN)}$ is not satisfied at the beginning of CAS before RAS self refresh cycles ($t_{RAS} < 100 \mu s$), CAS before RAS refresh cycles will be executed one time.

If $10 \mu s < t_{RAS} < 100 \mu s$, RAS precharge time for CAS before RAS self refresh (t_{RPS}) is applied. And refresh cycles (2,048/128 ms) should be met.

For details, please refer to **How to use DRAM User's Manual**.

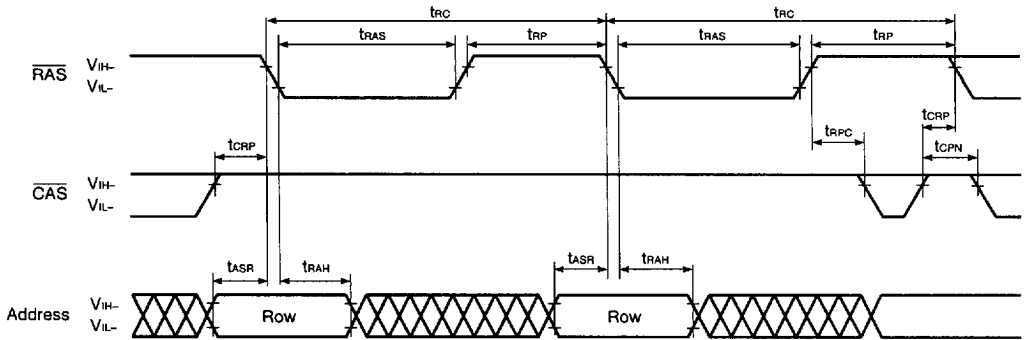
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CAS Before RAS Refresh Cycle



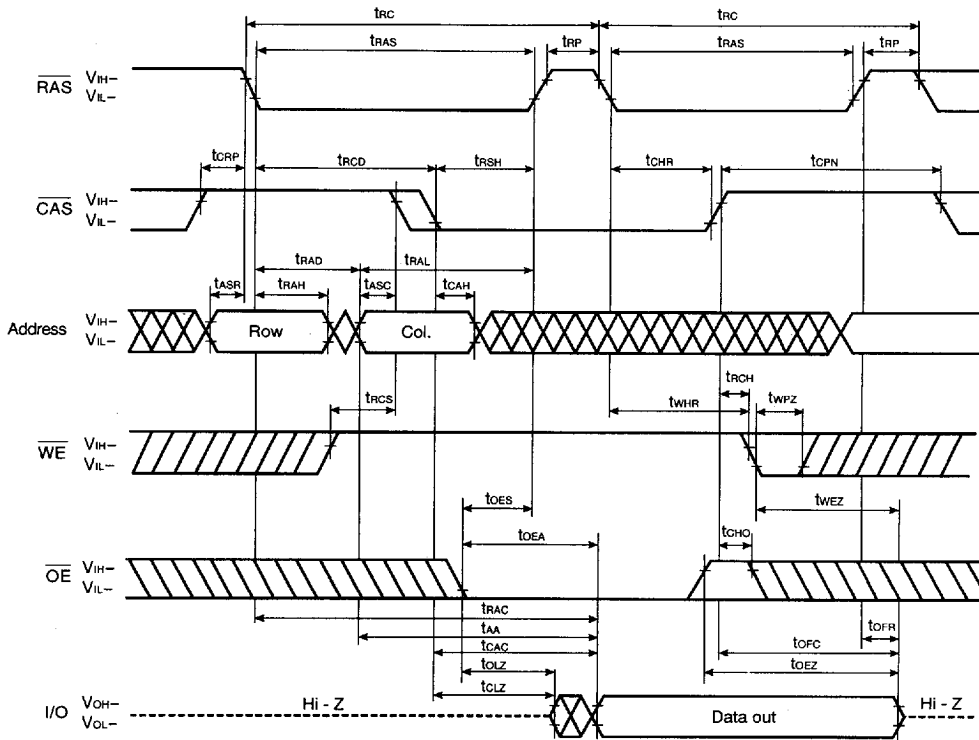
Remark Address, \overline{OE} : Don't care I/O: Hi-Z

RAS Only Refresh Cycle

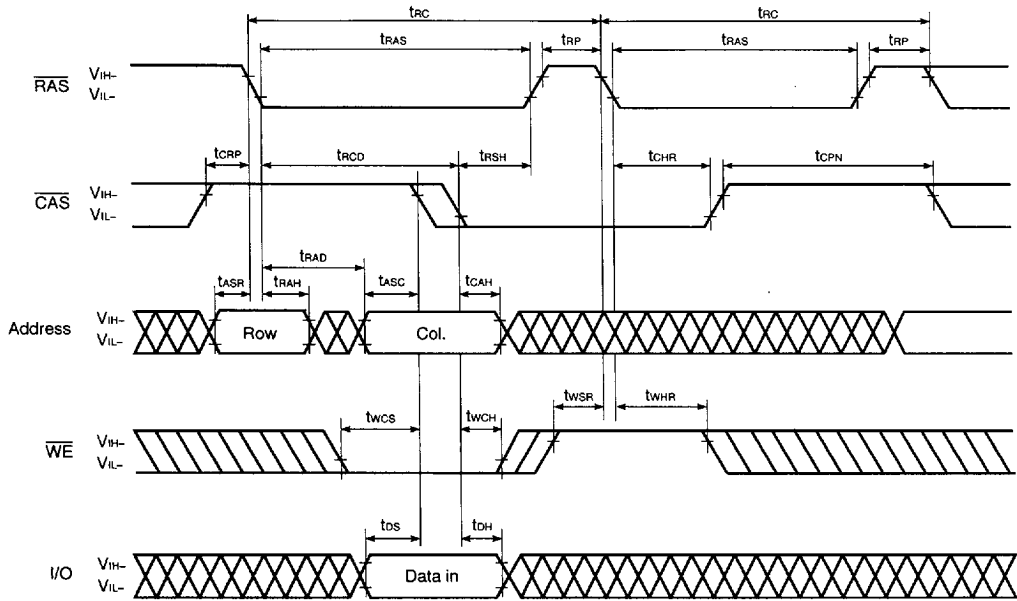


Remark \overline{WE} , \overline{OE} : Don't care I/O: Hi-Z

Hidden Refresh Cycle (Read)

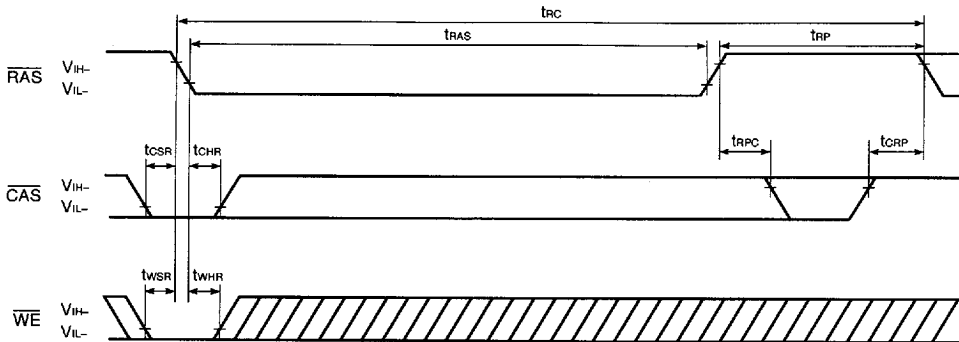


Hidden Refresh Cycle (Write)



Remark \overline{OE} : Don't care

Test Mode Set Cycle (\overline{WE} , \overline{CAS} Before \overline{RAS} Refresh Cycle)



Remark Address, \overline{OE} : Don't care I/O: Hi-Z

Test Mode

By using the test mode, the test time can be reduced. The reason for this is that, the memory emulates the 16-bit organization during test mode. Don't care about the input levels of the \overline{CAS} input A0.

(1) Setting the mode

Executing the test mode cycle (\overline{WE} , \overline{CAS} before \overline{RAS} refresh cycle) sets the test mode.

(2) Write/read operation

When either a "0" or a "1" is written to the input pin in test mode, this data is written to 16 bits of memory cell.

Next, when the data is read from the output pin at the same address, the cell can be checked.

Output = "1": Normal write (all memory cells)

Output = "0": Abnormal write

(3) Refresh

Refresh in the test mode must be performed with the \overline{RAS} / \overline{CAS} cycle or with the \overline{WE} , \overline{CAS} before \overline{RAS} refresh cycle. The \overline{WE} , \overline{CAS} before \overline{RAS} refresh cycle use the same counter as the \overline{CAS} before \overline{RAS} refresh's internal counter.

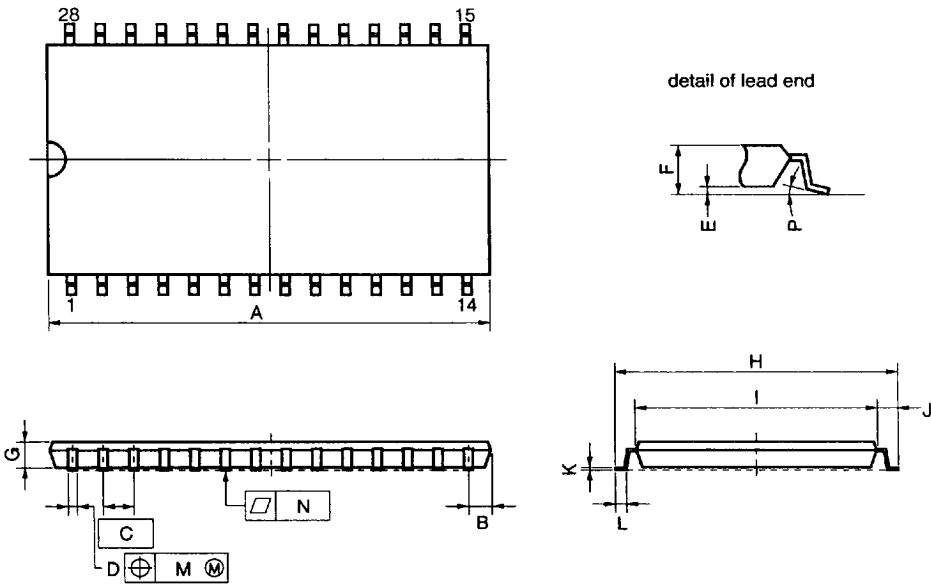
(4) Mode Cancellation

The test mode is cancelled by executing one cycle of \overline{RAS} only refresh cycle or \overline{CAS} before \overline{RAS} refresh cycle.

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Package Drawings

28PIN PLASTIC TSOP(II) (400 mil)



NOTE

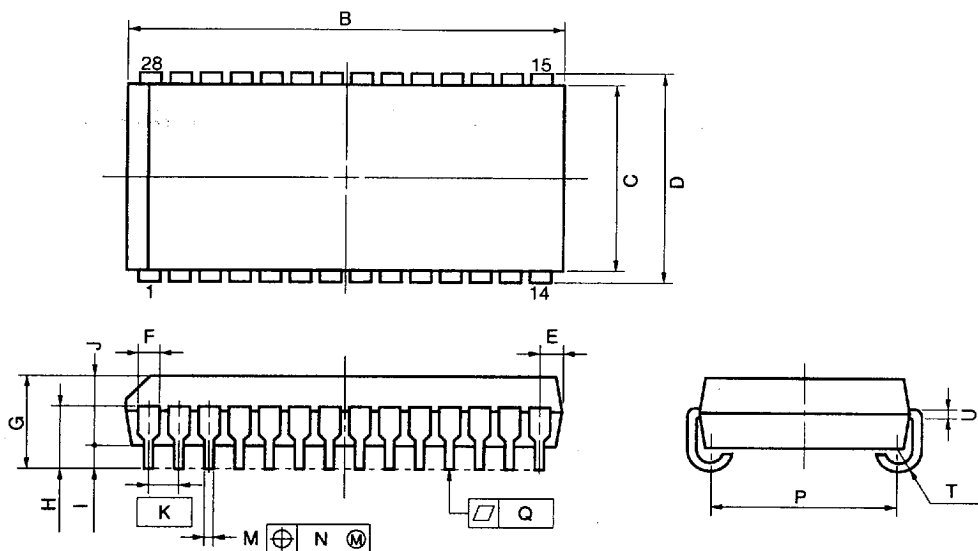
Each lead centerline is located within 0.21 mm (0.009 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
A	18.63 MAX.	0.734 MAX.
B	1.075 MAX.	0.043 MAX.
C	1.27 (T.P.)	0.050 (T.P.)
D	0.42 ^{+0.08} _{-0.07}	0.017±0.003
E	0.1±0.05	0.004±0.002
F	1.2 MAX.	0.048 MAX.
G	0.97	0.038
H	11.76±0.2	0.463±0.008
I	10.16±0.1	0.400±0.004
J	0.8±0.2	0.031 ^{+0.009} _{-0.008}
K	0.145 ^{+0.025} _{-0.015}	0.006±0.001
L	0.5±0.1	0.020 ^{+0.004} _{-0.005}
M	0.21	0.009
N	0.10	0.004
P	3° ^{+7°} _{-3°}	3° ^{+7°} _{-3°}

S28G5-50-7JD3

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28 PIN PLASTIC SOJ (400 mil)



NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

P28LE-400A1

ITEM	MILLIMETERS	INCHES
B	18.67 ^{+0.2} _{-0.35}	0.735 ^{+0.008} _{-0.013}
C	10.16	0.400
D	11.18±0.2	0.440 ^{+0.008} _{-0.007}
E	1.08±0.15	0.043 ^{+0.006} _{-0.007}
F	0.74	0.029
G	3.5±0.2	0.138 ^{+0.008} _{-0.007}
H	2.545±0.2	0.100±0.008
I	0.8 MIN.	0.031 MIN.
J	2.6	0.102
K	1.27 (T.P.)	0.050 (T.P.)
M	0.40±0.10	0.016 ^{+0.004} _{-0.005}
N	0.12	0.005
P	9.40±0.20	0.370 ^{+0.008} _{-0.007}
Q	0.10	0.004
T	R 0.85	R 0.033
U	0.20 ^{+0.10} _{-0.05}	0.008 ^{+0.004} _{-0.002}

Recommended Soldering Conditions

Please consult with our sales offices for soldering conditions of the μ PD42S17805L, 4217805L.

Types of Surface Mount Device

μ PD42S17805LG5, 4217805LG5 : 28-pin plastic TSOP (II) (400 mil)

μ PD42S17805LLE, 4217805LLE : 28-pin plastic SOJ (400 mil)